

Density functional theory study of the structural and electronic properties of amorphous silicon nitrides: Si3N4-x:H

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Density functional theory study of the structural and electronic properties of amorphous silicon nitrides: $Si₃N_{4-r}:H$

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We present ab initio density functional theory studies for stoichiometric as well as nonstoichiometric amorphous silicon nitride, varying the stoichiometry between $Si_3N_{4.5}$ and Si_3N_3 . Stoichiometric amorphous Si_3N_4 contains the same local structure as crystalline Si_3N_4 , with Si being 4-fold coordinated and N being 3-fold coordinated. Only few Si-Si and N-N bonds and other defects are found in stoichiometric silicon nitride, and the electronic properties are very similar to the crystalline bulk. In over-stoichiometric Si_3N_{4+x} , the additional N results in N-N bonds, whereas in under-stoichiometric $\text{Si}_3\text{N}_{4-x}$ the number of homopolar Si-Si bonds increases with decreasing N content. Analysis of the structure factor and the local coordination of the Si atoms indicates a slight tendency towards Si clustering, although at the investigated stoichiometries phase separation is not observed. In the electronic properties, the conduction band minimum is dominated by Si states, whereas the valence band maximum is dominated by lone pair N states. Towards Si rich samples, the character of the valence band maximum becomes dominated by Si states corresponding to Si-Si bonding linear combinations. Adding small amounts of hydrogen, as typically used in passivating layers of photovoltaic devices, has essentially no impact on the overall structural and electronic properties.

I. INTRODUCTION

Amorphous silicon nitride (a-Si₃N_{4−x}:H) is commonly used in the solar cell industry because it has three desirable properties. It serves as anti reflection coating and enhances light transmission, it is the main source of hydrogen (H) for passivating the silicon (Si) wafer and it chemically and physically passivates the surface.¹ The properties of a-Si₃N_{4−x}:H can be easily varied by changing the deposition parameters like the gas flow of $NH₃$ and SiH4, allowing the three properties to be tuned enhancing solar cell efficiency.² The material is most commonly fabricated by plasma enhanced chemical vapor deposition $(PECVD)$,^{1,3,4} but other deposition methods like sputtering are used as well.^{5,6}

Structural properties have been experimentally determined by T. Aiyama et al. and M. Misawa et al. using X-ray and neutron scattering.7,8 Furthermore, trapping centers have been investigated by electro paramagnetic resonance (EPR) measurements by P. M. Lenahan et al. and W. L. Warren *et al.*.^{9,10} As experiments are limited to microscopic and macroscopic investigations, it is difficult to link them to structural and electronic properties at the atomic scale. In order to fill this gap, computer simulations are performed to establish realistic atomic models and relate them to the observed macroscopic properties.

First insight into silicon nitrides at the atomic scale was provided by the seminal studies of J. Robertson *et al.* in the 90s.^{11–14} Robertson *et al.* applied tight binding methods to small, essentially crystalline model systems and investigated defect induced changes in the electronic properties. These results are still helpful, but, with the advances in ab initio density functional theory, it is possible to study the properties of amorphous silicon nitrides in much greater detail and using better founded approximations.

In more recent computer simulations, typically a small selection of a-Si₃N_{4−x}:H configurations were produced in order to investigate the structural, electronic, optical as well as vibrational properties.^{15–26} Few of these studies even examined the materials properties for different nitrogen concentrations^{17,20,25} and the effect of hydrogenation,^{18,21,22}. Nevertheless, the number of considered models was generally very small making statistically meaningful analysis difficult.

In order to build amorphous model structures different strategies are adopted. A common strategy is to assemble small subunits and clusters with proper short range order (SRO) into a continuous random network $(CRN)^{16}$ or Bethe lattice.^{21,27} Furthermore, bond switching methods can be applied to the crystalline samples until they become reasonably amorphous.22,28 Although very small defect concentrations are achievable by these strategies,²⁸ the most common and maybe most unbiased method to determine amorphous structures is by cooling the samples from the melt. This can be done by either Monte Carlo $(MC)^{17-19}$ or Molecular Dynamics $(MD)^{15,20,22-26,29}$ simulations.

Matter of fact, all simulations need to rely on a potential energy surface to calculate jump probabilities and forces during the cooling and relaxation. Ab initio methods are very desirable but incur great computational $\cot^{20,22-24,26}$ and hence many simulations are performed using different types of semi-empirical potential models (e.g. Tersoff, Thight Binding, Keating, Busing, Born-Mayer-Huggins).15–18,21,25,29 Both methods can be also combined in order to save computation time and/or to

FIG. 1: Volume per atom as a function of the N concentration $c_N = n_N/(n_N + n_{\text{Si}})$. The broken line shows the best linear fit to the experimental values (circles). The full line was obtained by readjusting the fit such that the density of crystalline Si is more accurately reproduced. This has only a slight effect on the root mean square error. The experimental data points for $Si₃N_x$:H are from M. Guraya *et al.*,⁶ the density for crystalline Si is from N. W. Ashcroft and N. D. Mermin.³

simulate larger systems. In this case, the samples are annealed using fast empirical potentials, and, afterwards, the electronic properties are calculated with more accurate ab initio methods.19,29

In present work, we present large-scale ab initio molecular dynamics studies on stoichiometric and nonstoichiometric Si_3N_{4-x} including up to 10 at.% H. Typically, we prepare 3 carefully quenched reference configurations with about 200 atoms for each considered stoichiometry. To allow for a statistically meaningful evaluation of defect related properties, 1000 small structural models with 100 atoms are then prepared for each stoichiometry. The main focus of the present work is an evaluation of the small models against the larger models, as well an evaluation of the average structural properties such as the pair correlation function, angular distribution function, structure factor, general features of the electronic density of states as well as the average local coordination of the atoms. A detailed analysis of the defect related properties is presented in a separate publication.

II. MODELLING SETUP

A. Compositions, concentrations and densities

Non-stoichiometric amorphous silicon nitrides exhibit large density variations that seemingly depend strongly on the applied preparation conditions.3,31,32

Here we mainly focus on amorphous silicon nitrides as used in solar cell industry and decided to determine the densities from the data published by M. Ippolito and S. Meloni.²⁵ We found it helpful to plot the average experimental volume per atom versus the nitrogen concen-

TABLE I: Densities ρ and volumes per atom of Si_3N_x as studied in the present work. The densities were derived from experimental values as shown in Fig. 1 (see also M. M. Guraya *et al.*).⁶ The table also shows the supercell volumes and the number of silicon $n_{\rm Si}$ and nitrogen atoms $n_{\rm N}$ in the considered supercells.

	Si ₃ N _{4.5}	Si ₃ N ₄	Si ₃ N _{3.5}	Si ₃ N ₃
ρ [g/cm ³]	3.22	3.14	3.06	2.98
volume per atom $[\AA^3]$	10.12	10.57	11.10	11.71
$n_N/(n_{\rm Si}+n_{\rm N})$	0.60	0.57	0.54	0.50
large supercell vol. $[\AA^3]$	1973	1999	2020	2014
$n_{\rm Si}$	78	81	84	86
$n_{\rm N}$	117	108	98	86
small supercell vol. $[\text{\AA}^3]$	1012	1033	1020	1077
$n_{\rm Si}$	40	42	42	46
$n_{\rm N}$	60	55	50	46

tration, as shown in Fig. 1. The volumes would lie on a straight line, if Vegard's law was observed.³³ Indeed, within the experimental uncertainties, this relation seems to hold very well, but the fit deviates from the volume of crystalline silicon in the Si rich case by more than 2 %. Increasing the slope improves this behavior for the Si rich case (full line) without deteriorating the root mean square error for the amorphous samples significantly. The final densities and volumes, as obtained from the fitted experimental data, are summarized in Tab. I.

The second issue to address is the influence of hydrogen on the volume. The experimental data were almost always measured in the presence of substantial amounts of H approaching up to $25 \text{ at.} \%$. Remarkably, however, hydrogen seems to influence the volume only very little. For instance, although for the data shown in Fig. 1, the H content varies from $15 - 25$ at.%, the deviation from Vegard's law is hardly noticeable, and for $Si₃N₄$ the volume of the amorphous structure agrees within few percent with the volume of crystalline $\beta - Si_3N_4$. This observation is reinforced by considering the small covalent radius of hydrogen. Even if we double the covalent radius, $d_{\rm H} = 2r_{\rm covalent} = 0.62$ Å (this value corresponds to the H-H bond length), and determine the corresponding volume, $V_{\rm H} = 4\pi \frac{d_{\rm H}^3}{3} \approx 1 \text{ Å}^3$, we obtain only small corrections to the volume. If the concentration were 20 at.[%] H, it would take up at most 3 % of the entire volume. This is certainly a rather crude consideration, since one could argue that hydrogen disrupts the usual bonding topology of the network and therefore might yield a significantly larger volume increase, but neither the experimental data nor any of our results seem to support this idea. Most likely, hydrogen simply accommodates in the network at defective or highly strained sites and hence causes only negligible changes in the volume.

To determine the hydrogen concentration typically found in a-Si₃N_{4−x}:H layers used in the fabrication of industrial solar cells, over 80 different $Si₃N_{4-x}:H$ samples

FIG. 2: Atomic concentration and bond densities estimated for plasma-enhanced-chemical-vapor depositioned (PECVD) silicon nitride. The dependency of the nitrogen concentration c_N is shown. The stochiometric case (Si_3N_4) is to the right. The values of $Si₃N₄, Si₃N_{3.5}H_{0.8}$ and $Si₃N₃H_{0.8}$, obtained by simulations, are marked with red symbols.

were prepared with plasma-enhanced-chemical-vapor deposition (PECVD) at the Energy Research Center of the Netherlands. A more detailed description of the PECVD method is given by W. Soppe.² The samples were analyzed using Fourier transform infrared spectroscopy (FTIR) and ellipsometry. From this data, the atomic concentration was extracted using the approach described by E. Bustarret *et al.* (see Fig. 2).³⁴ We expect that the hydrogen concentration is rather low for the stoichiometric case and, although the data show a large scatter towards the right side of the graph $(Si₃N₄)$, and the hydrogen concentration increases again for overstoichiometric samples $(Si₃N_{4+x})$, we decided to perform the simulations for the $Si₃N₄$ case without hydrogen. For the other, nitrogen deficient cases, we performed simulations without hydrogen and with approximately 13 at.% H. This seems to be well within the experimental range, which lies between 10 at.% and 15 at.% H for the considered stoichiometries.

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B. PAW potentials and technical parameters

All calculations presented in this work were performed using the Vienna ab intio simulation package (VASP) and PAW potentials in the implementation of Kresse and Joubert.35–38

Since our aim was to perform large scale simulations, we decided to construct special PAW potentials optimized for the specific application in mind. To this end, we chose for the PAW potentials the largest possible core radius that did not degrade the quality of the results noticeable. We found that core radii of 2.0 and 1.9 a.u. $(2.5 \text{ and } 2.4 \text{ a.u.})$ for the s-partial $(p\text{-partial})$ waves for N and Si, respectively, lead to acceptable results. For Si the d-potential was chosen as local potential, whereas for N the all-electron potential was smoothed inside a sphere with a radius of 0.8 a.u.. These potentials allowed to obtain converged total energies at a plane wave kinetic energy cutoff of about 150 eV. Results for bulk Si are essentially indistinguishable from more accurate PAW potentials, whereas results for $Si₃N₄$ are slightly deteriorated compared to accurate reference calculations, but the errors remain fairly small. The $Si₃N₄$ volumina of the bulk crystalline phases $(\alpha, \beta \text{ and } \gamma)$ are reproduced to within 1.5 %, and the relative energy difference between the α and γ phase, which is 1.05 eV per formula unit using accurate reference potentials, is reproduce to within 0.03 eV. The largest errors are observed for the zone centered phonons where discrepancies of the order of 5.0 % for some high frequency branches are observed, whereas the predicted DFT Kohn-Sham band gaps agree within 2 % with the accurate reference potential. All in all, the differences between the accurate reference potentials and the soft potentials are of the same order as the differences between the local density approximation and gradient corrected density functionals, which we believe to be a reasonable threshold. Furthermore, for liquid $Si₃N_{3.5}$ only small differences were found for the paircorrelation function and angular distribution function at 3000 K (see Fig. 3). For over-stoichiometric samples, however, the N-N distance is shifted by 0.2 Å to larger bond distances using the soft potentials, but this will not change the results for the experimentally relevant under-stoichiometric samples. This makes us confident that the present potential will give accurate results and is certainly far superior to conventional molecular dynamics potentials such as the Tersoff potential.²⁵ All simulations presented here have been performed with Brillouin sampling at the Γ-point, and the PBEsol functional was used.³⁹

Compared to the standard potentials requiring 400 eV cutoff, the savings are about a factor 5, and they allow us to perform much longer simulations than otherwise possible.

FIG. 3: The PC functions $g_{ij}(r)$ and angular distribution functions $a_{ijk}(\Theta)$ of a-Si₃N_{3.5} at 3000 K for different potentials. The soft potential (150 eV) used in our calculations gives within statistical uncertainties the same results as the harder reference (300 eV).

FIG. 4: Diffusion constants for Si_3N_x averaged over both atom types at different temperatures. Stoichiometric $Si₃N₄$ (red squares) always shows the highest freezing temperature.

1. Large simulation cells, slow annealing

Our initial strategy was to determine representative samples by cooling from the melt. Initially, we used fairly large simulation cells with a total supercell volume of about 2000 \AA^3 , and Tab. I summarizes the corresponding supercell volumes and the number of atoms we employed.

All systems were initially molten at 4000 K and then the temperature was gradually decreased until the atomic configuration started to freeze in. In all simulations, a time step of 1.5 fs was adopted, and the mass of hydrogen was increased to 10 atomic mass units. This mass increase will change the dynamics of the system, but has no influence on the explored configuration space, as the partition function factorizes into a momentum and configuration dependent part, with the later one being independent of the masses.

The "freezing" temperature was strongly dependent on the stoichiometry, as demonstrated in Fig. 4, where the diffusion constant averaged over both atom types is plotted versus the temperature. When the value drops significantly below $0.05 - 0.1 \text{ Å}^2/\text{ps}$, it is difficult to determine accurate diffusion constants. Monitoring the mean square displacement for these cases indicates jump diffusion occurring every few ps. It is likely that this is defect mediated, since the network can easily re-adjust and relink at defects, and, consequently, the defect might migrate through the network. But a detailed investigation of this issue is beyond the scope of the present work. Stoichiometric Si₃N₄ freezes in at about 3000 – 3100 K on a timescale of $20 - 40$ ps, which we observed repeatedly for several simulations at different system sizes, and the freezing goes along with the geometrical defects being progressively removed during the annealing. Usually the system locks in when two or zero defects are present in the sample (for topological reasons the defects always come in pairs for stoichiometric $Si₃N₄$). The observed amorphisation temperature seems to be significantly larger than the experimental estimates of about 2000 K. 40,41 But we note that the melting temperature of silicon nitride can not be measured, since the solid decomposes into atomic and molecular Si and N before melting sets in (gas pressure of Si).

Matter of fact, our simulations are also hampered because of the short timescales and system sizes that are accessible to us: once all defects are cured, the system locks in. In real experimental samples, the density of mobile defects will only exponentially approach zero, sustaining diffusion at much lower temperatures. Furthermore, we believe that the experimental samples are never perfectly stoichiometric. Even being slightly offstoichiometric, diffusion is enhanced since some defective bonds (e.g. Si-Si bonds) or coordination defects prevail. For $Si₃N_{3.5}$ and $Si₃N_{4.5}$, amorphization occurs at roughly 2600 K, whereas, for $Si₃N₃$, the freezing occurs at roughly 2300 K. We also note that jump diffusion is well possible below these temperatures, but these events are very rare on the timescales accessible to us. Finally, addition of 10 at.% H, generally lowers the amorphization temperature by another 200 K (not shown).

The adopted temperature profiles are shown in Fig. 5. In retrospect, we could have fine tuned the cooling history somewhat for each stoichiometry, for instance by progressively elongating the runs when approaching the freezing temperature, but we believe that this will change the final

FIG. 5: Annealing history adopted in the present work for the large $Si₃N_x$ systems. Because $Si₃N₄$ freezes at about 3100 K, the system was equilibrated for 30 ps at 3500 K, then the system was cooled to 3000 K and annealed at this temperature until most defects were removed. For the other stoichiometries 20 ps annealing was performed at 3000 K, and then the temperature was gradually decreased to 2000 K equilibrating at each temperature for 10 ps.

results only little. In order to prepare a set of samples, we extended the simulation runs at $3500 \text{ K (Si}_3\text{N}_4)$ and 3000 K ($Si₃N_{4-x}:H$) followed by the same annealing history as for the original samples. In this manner, three samples were generated for $a-Si_3N_4$, $a-Si_3N_3$, $a-Si_3N_3$. For the less relevant $a-Si_3N_{4.5}$ and the hydrogenated samples only a single large representative structure was generated.

2. Small simulation cells

The drawback of the strategy adopted above is that it is difficult to generate any statistics for the defect related properties. Even with three samples, we can not determine how likely the formation of a certain defect class is. To complement the simulations of the large systems, we therefore performed simulations for smaller systems containing about 100 atoms. In this case, the simulation was run for up to 1 ns just above the freezing temperature, and every 500-1000 steps a configuration was quenched into the closest local minimum using a standard minimization procedure. This approach allowed us to generate about one thousand reasonably independent samples for each stoichiometry. The corresponding runs typically required 4 weeks on 32 cores each.

In Fig. 6, we show the acquired mean square displacements (MSD) of 4 different stoichiometries. The diffusion constants are roughly similar and constant over the simulation time. Lowering the temperature by $50 - 100$ K usually resulted in rapid freezing of the structures. The chosen stoichiometries correspond roughly to the same stoichiometries as those considered for the large systems.

FIG. 6: Mean square displacements (MSD) of 4 different $Si₃N_{4-x}:H$ ensembles. The averaged temperature is given after the system label. The temperatures were adjusted to keep the ensembles just above the freezing temperature. In some cases, the temperature had to be increased and the simulation restarted before the freezing, when accidental freezing occurred.

Only for the "stoichiometric" case, we removed one N atom resulting in a stoichiometry of roughly $Si₃N_{3.9}$ in order to avoid that all defects accidentally annihilate, which might have resulted in a "lock-in" at temperatures even above 3100 K.

III. STRUCTURAL PROPERTIES

The main focus of the present work is on general structural properties, whereas a detailed analysis of the electronic properties of defects and defect statistics is reserved for a later publication. In the following sections we evaluated the pair correlation function, structure factor, angular distribution function and the local bonding topology at the Si and N sites.

A. Pair correlation function

The pair correlation (PC) functions for the quenched amorphous samples are shown in Fig. 7. For the large systems, the results were averaged over 3 samples (except for $Si₃N_{4.5}$, where only a single structure was generated), whereas for the small systems the average was done over about 1000 samples. In addition to the PC function, we analyzed the average number of nearest neighbors by integration of the partial PC functions between 0 and the first minimum r_{\min} in the respective function (see

FIG. 7: Partial pair correlation functions $g_{ij}(r)$ for the small (full line) and the large $Si₃N_x:H$ systems (broken line). Hydrogen (crosses) leaves the PC function largely unchanged.

Tab. II):

$$
N_{ij} = \rho_{h_j} \int_0^{r_{\min}} dr \ 4\pi r^2 \ g_{ij}(r).
$$
 (1)

TABLE II: The partial coordination numbers N_{ij} evaluated for small ensembles. N_{ij} specifies for atom i the number of nearest neighbors of type j.

	$Si_3N_{4.5}$	Si_3N_4	Si ₃ N _{3.5}	Si ₃ N ₃
$N_{\rm SiN}$	4.16	3.95	3.57	2.99
$N_{\rm SiSi}$			0.38	1.01
$N_{\rm NSi}$	2.77	3.02	3.00	2.99
$N_{\rm NN}$	0.30			
	$Si3N3.5H0.4$	$Si3N3.5H0.8$	$Si3N3.5H1.7$	$Si3N3H0.8$
$N_{\rm SiN}$	3.51	3.47	3.40	2.97
$N_{\rm SiSi}$	0.48	0.35	0.33	0.93
$N_{\rm NSi}$	2.94	2.91	2.85	2.97
$N_{\rm NN}$				
$N_{\rm HSi}$	0.51	0.51	0.47	0.70
N_{HN}	0.48	0.44	0.38	0.24
$N_{\rm HH}$	0.04	0.06	0.13	0.06

Also the mean bonding distance \overline{d}_{ij} and the standard deviation σ_{ij} were evaluated by integrating up to the first minimum (see Tab. III)

The first important observation is that the PC functions of the small (black solid lines) and the large systems (black broken lines) are very similar, in particular, at large distances beyond the first nearest neighbor. This is a little bit counterintuitive, since we would rather expect differences at long distances due to finite size effects, but at large distances we only recognize slightly more scatter for the large system, which points towards insufficient sampling over different configurations. However, at the distance of the first nearest neighbor, the PC function for the large systems shows somewhat more pronounced and narrower peaks for N-N and Si-Si. We believe that this is related to the slower and more careful annealing performed for the large systems. Recall that the small systems were created by directly quenching from the melt. In all other respects, the small systems seem to adequately represent the amorphous structure, and specifically finite size effects at large distances are largely absent in the small simulation cell, at least at the level of the PC function

The second remarkable observation is that hydrogen, in the low concentrations considered here, has virtually no discernible effect on the PC function (compare full line with red crosses). It rather seems that hydrogen only participates as a "spectator" decreasing the connectivity and increasing self-diffusion, with no dramatic effect on the average structural properties of the amorphous structure, as evaluated by the PC function. For $Si₃N_{3.5}H_{0.8}$ and $Si₃N₃H_{0.8}$, the mean hydrogen bonding distances are 0.77 ± 0.01 Å for \bar{d}_{HH} , 1.50 ± 0.07 Å for d_{HSi} , and 1.11 \pm 0.04 Å for \bar{d}_{HN} .

The present PC functions agree very well with previous simulations. The Si-N PC functions shows a pronounced peak at 1.75 Å, which hardly shifts with varying stoi-

TABLE III: Mean bonding distances and standard deviations and position of the minimum in the pair correlation function of the $Si₃N_x$ evaluated for small ensembles (all values are in Å). For the non stoichiometric systems, peaks emerge at short distance corresponding to direct Si-Si and direct N-N neighbor atoms at 2.4 A and 1.6 A, respectively.

Si-Si	$\rm Si_3N_{4.5}$	$\mathrm{Si}_3\mathrm{N}_4$	Si ₃ N _{3.5}	Si ₃ N ₃
$1^{\rm st}$ $d_{\rm SiSi}$			2.40	2.38
1 st $\sigma_{\rm SiSi}$			0.10	0.10
$1^{\rm st}$ $r_{\rm min}$			2.57	2.59
2^{nd} $d_{\rm SiSi}$	3.00	2.99	3.02	3.02
2^{nd} $\sigma_{\rm SiSi}$	0.22	0.24	0.19	0.19
2^{nd} r_{\min}	3.56	3.56	3.53	3.49
$N-N$	$\mathrm{Si}_3\mathrm{N}_{4.5}$	$\mathrm{Si}_3\mathrm{N}_4$	Si ₃ N _{3.5}	Si ₃ N ₃
$1^{\rm st}$ $\bar{d}_{\rm NN}$	1.62			
1 st $\sigma_{\rm NN}$	0.06			
$1^{\rm st}$ $r_{\rm min}$	1.98			
2^{nd} \bar{d}_{NN}	2.86	2.89	2.90	2.89
2^{nd} $\sigma_{\rm NN}$	0.26	0.26	0.25	0.23
2^{nd} r_{\min}	3.54	$3.62\,$	3.63	3.58
$Si-N$	$\mathrm{Si}_3\mathrm{N}_{4.5}$	$\mathrm{Si}_3\mathrm{N}_4$	Si ₃ N _{3.5}	Si ₃ N ₃
$1^{\rm st}$ \bar{d}_{SiN}	1.75	1.75	1.75	1.75
$1^{\rm st}$ $\sigma_{\rm SiN}$	0.09	0.08	0.07	0.07
$1^{\rm st}$ r_{\min}	2.26	2.30	2.30	2.30

chiometry, and in fact, the entire Si-N PC function is almost entirely independent of stoichiometry. Inspection of Tab. II shows that each N atom forms three bonds, whereas the number of bonds formed by the Si atoms is always very close to four (sum of N_{SiN} and N_{SiSi}). For stoichiometric $Si₃N₄$, the Si-Si PC function shows one strong peak at 3.0 Å, which is related to the distance between Si atoms in Si-N-Si triangles, and similarly the N-N PC function shows a peak at 2.90 Å related to N-Si-N triangles. The other feature worthwhile mentioning is the small shoulder in the Si-Si PC function around 2.6 Å. As already discussed by Giacomazzi $et al.,$ it is mostly related to planar Si-N-Si-N squares.²³ For sub-stoichiometric $Si₃N_{4-x}$ this peak seems to develop into a pronounced shoulder around 2.4 Å , but in fact, the origin of this shoulder are direct Si-Si bonds, as shown in the number of direct Si-Si neighbors N_{Sisi} in Tab. II, which increases from 0.38 in $Si₃N_{3.5}$ to 1 in $Si₃N₃$. Likewise direct N-N bonds form in over stoichiometric Si_3N_{4+x} , as indicated by a value of $N_{NN}=0.3$ in $Si₃N_{4.5}$. The absence of direct N-N neighbors in stoichiometric and sub-stoichiometric $Si₃N_{4-x}$, and likewise the absence of direct Si-Si neighbors in stoichiometric and over-stoichiometric Si_3N_{4+x} is a clear indication for the strong ordering tendency in silicon nitrides, as direct bonds to the same species are only formed if the material contains too much Si (Si-Si bonds) or too much N (N-N bonds). In summary, the amorphous structures are characterized by (i) 4-fold coordinated Si atoms and 3-fold coordinated N atoms, with (ii) a strong tendency towards hetero-coordination and formation of Si-N bonds. The partial coordination numbers also reveal that hydrogen indeed disrupts the normal network topology of silicon nitride. For $Si₃N_{3.5}H_{0.8}$, it forms bonds with both Si and N atoms, whereas for $Si₃N₃H_{0.8}$ bonds are predominantly formed to Si atoms. Of course such bonds reduce the number N-Si bonds, for instance $N_{\rm NSi}$ drops from 3.0 to 2.91 in $Si₃N_{3.5}H_{0.8}$, and the sum $N_{SiSi}+N_{SiN}$ decreases from 4 to 3.9 when hydrogen is added in $Si₃N₃H_{0.8}$.

To investigate the dependence on the H content, we also performed calculations for concentrations of 6 at.% and 20 at.% H for $Si₃N_{3.5}$. As can be recognized from Tab. II the probability that hydrogen attaches to silicon or nitrogen is pretty much independent of the H content but changes with stoichiometry. For $Si₃N_{3.5}$ and $Si₃N₃$, about 50 % and 70 % of the H bonds to Si, respectively, whereas the number of hydrogen bonded to nitrogen decreases with decreasing N content. These results are in good agreement with experiments (compare Fig. 2 bottom panel, also see Ref. 6,42). It is also quite clear and not unexpected, that the number of H "dimers" increases with the H content, but it remains fairly small up to about $10 - 15$ at.% H.

For stoichiometric $Si₃N₄$, we can compare the present bonding distances and the bonding angles with experimental data obtained by T. Aiyama et al. and M. Misawa et $al^{7,8}$ and with results from the simulations performed by L. Giacomazzi et al. and K. Jarolimek et al.. 23,24 The present mean values have been calculated by averaging the bond length over the bonds up to the first minimum r_{\min} tabulated in Tab. III. Our mean distances are 3.0 Å for d_{SiSi} , 2.9 Å for d_{NN} and 1.75 Å for $\overline{d}_{\text{SiN}}$. These values agree very well with previous experiments and simulations, as shown in Tab. IV.

TABLE IV: Reference values for the bond lengths in $a-Si_3N_4$ obtained by experiments and simulations (all values are in \AA).

	3.00	3.00	1.75
	3.01	2.83	1.73
2.42	3.03	2.76	1.73
2.35-2.41	3.10	2.90	1.76
			1^{st} \bar{d}_{Sis} 2^{nd} \bar{d}_{Sis} 2^{nd} \bar{d}_{NN} 2^{nd} \bar{d}_{Si}

For Si rich samples, the direct Si bond distance is located at 2.4 Å, again in excellent agreement with previous simulations for amorphous $Si₃N_x:H$ (and in good agreement with simulations for amorphous Si).^{23,24,43}

Over-stoichiometric $Si₃N_{4.5}$ was investigated by M. Ippolito and S. Meloni using Tersoff potentials finding a peak in the N-N PC function around 1.3 \AA .²⁵ In view of our present value of 1.62 Å this seems a little bit too short, but we have already emphasized that this peak distance is somewhat overestimated due to the use of a very soft N potential. After relaxation using harder potential, the mean distance moves to 1.45 Å , which is still larger than the value for the Tersoff potential. Our present simulations, also agree with previous ab-initio simulations in predicting no direct N-N neighbors in stoichiometric and sub-stoichiometric $Si₃N_{4-x}$, whereas the previous force field simulations showed direct N-N bonds even in slightly sub-stoichiometric Si_3N_{4-x} . This clearly points towards some deficiency in the Tersoff force fields.

B. Angular distribution function

FIG. 8: The angular distribution functions of \angle _{SiNSi} and \angle _{NSiN} for the large and the small Si_3N_x : H systems relative to the same distribution in a hypothetical ideal gas with the same density and composition. The distribution function is, therefore, normalized by a factor of $1/\sin(\theta)$ amplifying contributions at 0◦ and 180◦ . Two Si and two N atoms arranged in a square result in pronounced peaks at 90◦ .

In Fig. 8, we show the angular distribution functions for different Si_3N_x compositions, with and without hydrogen. As before for the pair correlation function, hydrogen influences the angular distribution function very little. Regardless of stoichiometry, the main peaks are located at mean angles of 110[°] for silicon, and 120[°] for nitrogen. The value of $120° = 360°/3$ is in perfect agreement with the value expected for a flat triangle formed by three Si atoms surrounding a central N atom. This again confirms that the local bonding topology of nitrogen changes very little compared to crystalline $Si₃N₄$, where each N atom is surrounded by three Si atoms forming a coplanar triangle. This is also consistent with the electronic configuration of nitrogen, forming three sp^2 hybrid orbitals that interact with the three Si neighbors, and one out of plane lone pair p orbital that is doubly occupied and oriented perpendicular to the NSi₃ plane. Furthermore, a second peak is visible at 90° in the angular distribution function. This peak stems from N-N neighbors in a planar Si-N-Si-N arrangement, as shown in the inset.

The bond angle distribution for silicon is strongly peaked at a mean angle of 110◦ . This again agrees perfectly with the expected tetrahedral bonding angle of 109.5°. As for nitrogen, this suggests that the Si atoms maintain their sp^3 hybridization forming bonds with the four neighboring atoms. These are N atoms in the stoichiometric case, and possibly few Si atoms in the substoichiometric case $Si₃N_{4-x}$. Again a clear secondary peak is visible at 90° related to the planar Si-N-Si-N arrangement already mentioned above. For both silicon and nitrogen this peak loses intensity when moving to sub-stoichiometric compositions. This relates well to the observation that the number of Si-N-Si-N square configurations decreases when the amount of nitrogen deviates from the perfect stoichiometry $Si₃N₄$.

C. Structure factor

Information about long range order and density fluctuations are most easily investigated by an ensemble average of the Faber-Ziman structure factor $S(\mathbf{k})^{44-47}$

$$
S(\mathbf{k}) = \frac{1}{N} \left\langle \sum_{i} \sum_{j} \exp[-i\mathbf{k}(\mathbf{r}_{i} - \mathbf{r}_{j})] \right\rangle, \qquad (2)
$$

where k are wave vectors and N is the total number of atoms and \mathbf{r}_i are the atomic positions. Consistent with the finite supercell, we evaluated the structure factor on a grid of reciprocal lattice vectors k that are compatible with the applied supercell (and not by a Fourier transformation of the pair-correlation function). From the structure factors $S(\mathbf{k})$ on the grid, the isotropic structure factor is calculated by averaging over different k orientations and properly weighing each contribution:

$$
S(q) = \frac{\int S(\mathbf{k}) \,\delta(|\mathbf{k}| - q) \,d^3k}{4\pi q^2}.\tag{3}
$$

The partial structure factors for each atom type $S_{\alpha\alpha}(q)$ were obtain by summation over one atom type in Eq. (2). To calculate the partial structure factors $S_{\alpha\beta}(q)$ with $\alpha \neq \beta$ we use the implicit equation

$$
S_{\alpha+\beta}(q) = \sum_{\alpha\beta} (c_{\alpha}c_{\beta})^{\frac{1}{2}} S_{\alpha\beta}(q), \qquad (4)
$$

where c_{α} is the concentration of atom type α and $S_{\alpha+\beta}(q)$ is the total structure factor of both atom types.⁴⁶

In Fig. 9 the structure factors are shown for the large supercells, since the small simulation cells result in a fairly coarse reciprocal space grid, causing a nonmonotonic behaviour (qualitatively the results are, however, similar as one would expect from the close agreement for the pair correlation function).

In general, the structure factors change little with composition, and in all cases, the main peak is observed at 2.2 Å^{-1} which agrees with the results of K. Jarolimek et $al.^{24}$ The corresponding wave length is roughly 2.8 Å agreeing well with the typical Si-Si and N-N distances in the pair correlation function. This indicates that the peak is mostly a residual of the Fourier transform of the first peak in the pair correlation, rather than a true long range order. Remarkably the SiN structure factor shows a strong anti-correlation at this wavelength, indicating a moderate medium range order with alternating Si-N-Si-N planes where the distance between the Si-Si and N-N planes is roughly 2.8 Å. This medium range order clearly decreases when moving off stoichiometry, most likely because Si-Si bonds are introduced into the network necessarily causing a disruption of the alternating planes.

The other important observation is the increase of the NN structure factor S_{NN} towards small wave vectors q , with decreasing Si content. A similar increase is also observed for the small samples (not shown). Such an increase usually indicates the onset of long range density fluctuations, i.e. there are regions in our simulation cell, where N accumulates and regions where N becomes depleted. For sufficiently large simulation cells and sufficiently long simulation times, one might observe phase separation into a Si rich part with few N impurities, and a close to stoichiometric $Si₃N₄$. For the simulation cells and stoichiometries considered here, this effect was however hardly noticeable in real space. As shown in the next section, some residual of the phase separation is observable even in the local coordination upon careful investigation.

D. Clustering or simple percolation

We now briefly return to the analysis of the local bonding properties of Si. As we have already shown in Tab. II most Si atoms have four nearest neighbors, whereas the N atoms are all 3-fold coordinated. Furthermore Tab. II shows that N atoms form bonds exclusively to Si in the stoichiometric and sub-stoichiometric case $\rm Si_3N_{4-x}$ (N_{NSi}) . In the absence of H, this allows to estimate the

FIG. 9: Partial Faber-Ziman structure factors $S_{\alpha\beta}(q)$ for the large $Si₃N_x:H$ systems.

partial Si coordination number to be $N_{\text{SiSi}} = x$, which is

FIG. 10: Detailed analysis of the bonding topology for 4-fold coordinated Si atoms. The actual probability of finding a Si atom coordinated to n N and $(4 - n)$ Si atoms is shown. Also shown is the distribution that one would expect if the formation of a Si-Si bond were entirely random. Excess probabilities are found towards the two end points in particular for $Si₃N₃$, which is consistent with a tendency towards Si clustering and "phase separation".

indeed roughly observed in Tab. II.

If the formation of Si-Si bonds were random, we would expect that the distribution of 4-fold coordinated Si atoms with n nitrogen and $(4-n)$ silicon neighbors would be roughly binomial

$$
p(n) = \frac{4!}{n!(4-n)!} \left(\frac{x}{4}\right)^{(4-n)} \left(\frac{4-x}{4}\right)^n.
$$
 (5)

In Fig. 10 we show the actual distribution of the bonding topology of 4-fold coordinated Si atoms and compare it with the binomial distribution that would be expected if the formation of Si-Si bonds where entirely random. The most notable observation is that we would not expect any Si atoms with three Si neighbors in $Si₃N_{3.5}$, and no Si atoms with four Si neighbors in $Si₃N₃$, however, the actual analysis shows that such atoms exist. This is a sign that Si prefers either exclusively N neighbors or exclusively Si neighbors, which is consistent with our previous analysis of the structure factor and supports the claim that a tendency towards phase separation exists, although in the present case, it manifests itself only in the form of a slight tendency towards Si clustering, that goes beyond what one would expect for a random percolating network.

IV. ELECTRONIC PROPERTIES

A. Density of states

The silicon and nitrogen projected electronic density of states (DOS) is provided in Fig. 11, together with

FIG. 11: Site projected electronic DOS for Si and N atoms in the small Si_3N_x : H systems. The broken line corresponds to the DOS of crystalline β -Si₃N₄. The density of states are aligned in a such a way that the N core levels have always the same energy. The Fermi-levels are located exactly at the minimum of the individual DOS.

the DOS of crystalline β -Si₃N₄, which was already discussed by G. Kresse.⁴⁸ Averaging was done over all small samples (approximately 1000 for each stoichiometry). To align the individual DOS for different configurations and stoichiometries, we have chosen the average nitrogen 1s core level energies as reference.

Since the local short range order of $a-Si₃N₄$ is very similar to β -Si₃N₄ we expect similar electronic properties as in the crystalline phases, which is indeed confirmed (compare with broken line in Fig. 11). As for structural properties, we again find that hydrogen has virtually no discernible influence on the average electronic properties, although a detailed discussion of the properties of the defect states close to the Fermi-level is postponed to a later study.

The lowest valence band is made up by N 2s states (not shown). The second lowest subband $(-11 \text{ to } -4 \text{ eV})$ is predominantly made up by bonding $N 2p$ states. As already discussed, N atoms are located in an almost planar triangular configuration with 3 Si neighbors $(NSi₃)$. The N $2p$ band is made up by two p orbitals per N atom, and shows significant hybridization with Si p states in particular at energies around −10 eV. The final subband below the Fermi level at -2.5 eV is dominated by the non-bonding N 2p states (one orbital per N atom) that is oriented out of the plane formed by the $NSi₃$ triangle. This band shows only very little hybridization with Si. As the Si concentration increases, a marked change is observed in the DOS below the Fermi-level with a significant increase in the Si DOS and little to no changes in the N DOS. In stoichiometric $Si₃N₄$, the dominant contribution to the electronic states below the Fermi-level is stemming from the N 2p lone pair orbitals, however, for Si_3N_{4-x} the Si DOS increases rapidly with decreasing N content. This property is easily understood to result from the increase in the number of Si-Si bonds. The bonding antiboding splitting for a Si-Si bond is far smaller than for the shorter Si-N bond: for a Si-N bond, the bonding $Si-3p$ N-2p linear combination is pushed at least -3 eV below the Fermi-level, whereas for a Si-Si bond, the bonding linear combinations is located just below the Fermi-level. Matter of fact, this also relates to the smaller band gap in crystalline Si or amorphous-Si (compared to Si_3N_4). We thus expect that valence band defect states have important contributions from Si-3p states in sub-stoichiometric $Si₃N_{4-x}$, whereas N related lone pair states dominate in stoichiometric $Si₃N₄$. The other notable observation is that the Fermi-level is pushed upwards by 0.5 eV, as the stoichiometry changes from $Si₃N₄$ to $Si₃N₃$, in agreement with the less electronegative character of Si. Again we stress, that we have aligned the electronic DOS at the N 1s core level, but this seems to be a rather sensible approach, since the local coordination of the N atoms remains virtually unchanged from $Si₃N₄$ to $Si₃N₃$.

B. Inverse participation ratio

It is commonly expected that the inverse participation ratio (IPR) increases for states in the gap (see e.g. J. F. Justo et $\hat{a}l$.).¹⁹ In the present case, we show the results only for the large systems, because the values for the small systems remain more bounded. The IPR is calculated as

$$
p_n^{-1} = \frac{N \sum_{j,l} \left| \psi_{n,l}(\mathbf{r}_j) \right|^4}{\left(\sum_{j,l} \left| \psi_{n,l}(\mathbf{r}_j) \right|^2 \right)^2}
$$
(6)

where $\psi_{n,l}(r_j)$ is the projection of the orbital n onto the atomic site j and angular quantum number l . The sum is performed over all atoms j and the angular momentums l , whereas N is the total number of atoms. If all atoms participate in an electronic state n, p_n^{-1} becomes equal to one, and, if the state is completely localized on one atom, p_n^{-1} approaches N.

Fig. 12 shows the partial (N and Si) resolved DOS and the IPR for a-Si₃N₄ and a-Si₃N₃. For stoichiometric a- $Si₃N₄$, we found very localized states at the valance band edge and a DFT band gap of about 2 eV. Furthermore, for the considered snapshot no defect states are visible in the gap, in agreement with results of L. Giacomazzi and P. Umari,²³. As discussed above, the band gap becomes smaller and the DOS increases close to the Fermi-level when moving off stoichiometry, in particular, the Si DOS increases around the Fermi-level, in accordance with the observations made already in the previous section. It is also clearly visible that this results in much weaker localization, and smaller IPR values for the states at the valence and conduction band edges as well as in the band gap.

FIG. 12: Density of states projected onto Si and N atoms and the inverse participation ration (IPR) for $a-Si_3N_3$ (red) and $a-Si_3N_4$ (black).

C. Optical band gap

A three step procedure following roughly the experimental methods is used to determine the optical band gap. In the first step, we calculated the absorption coefficient $\alpha(E)$ from the independent particle dielectric function calculated using density functional theory orbitals and one-electron energies. $^{49-51}$

Second, we determine the DFT optical band gap either as E_{04} , the energy value where the absorption coefficient α reaches the threshold of 10⁴ cm⁻¹, or as the Tauc band gap E_T where the linear regression of the linear regime gap E_T where the linear regression of the linear regime
of $\sqrt{\alpha E}$ crosses the energy axis. In our case the linear regime is between 6 and 9 eV. The corresponding data are shown in Fig. 13 and are explained in more detail by J. Robertson, A. R. Zanatta and I. Chambouleyron, and J. Tauc.12,52,53

Finally, we applied the GW_0 approximation^{54–57} to a set of 40 representative slowly cooled samples for each stoichiometry in order to correct the DFT band gaps which are well known to underestimate experimental quasi-particle band gaps. The GW_0 calculations were performed by iterating the eigenvalues in the Green's function until selfconsistentcy was reached.^{58,59} The orbitals were kept fixed to the Kohn-Sham orbitals. We included typically 3500 unoccupied states, and one calculation required about 2 hours on 64 cores. Doubling the number of unoccupied orbitals increased the quasiparticle band gap by less than 100 meV. The calculational details are otherwise similar to Ref. 48.

Fig. 14 shows that the unoccupied states of $Si₃N_{3.5}$, with and without hydrogen, are rigidly shifted upwards by 1.17 eV compared to the occupied states. Furthermore, in the vicinity of the gap the $GW₀$ quasi-particle energies exhibit a slightly increased slope compared to the DFT one-electron energies. This slope is almost constant for the valence band and conduction band states and amounts 1.13. Disregarding the corrections for the slope, we can simply add an optical band correction of $\Delta = 1.17$ eV to the DFT values E_{04} and E_T . The scissor gap corrections Δ for the other systems are summarized in Tab. V.

In Fig. 15, we compare the corrected data of E_{04} and E_T with the experimental results obtained by M. M. Guraya *et al.*.⁶ As one can see the values of E_{04} are generally greater than E_T , but both lie only slightly below the experimental reference, and follow the experimental data quite well. We note in particular the sharp decrease of the band gap, when one approaches the stoichiometry of $Si₃N₃$, which is a result of the increasing number of Si-Si bonds, the resultant percolation network and accompanied by a change of the valence band states from N lone pair to Si-Si bonding linear combinations (compare Fig. 11). In passing we note, that a scissor correction will not modify the density of states presented in Fig. 11, but for a trivial upshift of the conduction band states and an opening of the gap between the valence band and conduction band states.

FIG. 13: Optical band gap of $Si_3N_xH_y$ from density functional theory estimated by applying a threshold of 10^4 cm^{-1} to the absorption coefficient α and by using the Tauc linear regression.⁵² The bisections give the corresponding results E_{04} and E_T . To compare with experiment the DFT date need to be blue shifted by about 1.2 eV (compared Tab. V.

TABLE V: Parameter obtained by fitting the linear function $y = kx + \Delta$ to the and GW₀ quasi-particle energies as a function of the DFT one-electron energies for a- $Si₃N_xH_y$ (compare Fig. 14). The scissor correction Δ is added to the optical DFT band gap values determined in Fig. 13.

	$Si_3N_3H_{0\setminus0.8}$	$Si3N3.5H0\setminus0.8$	Si ₃ N ₄
\boldsymbol{k}	1.18	1.13	1 12
Δ	0.79 eV	1.17 eV	1.19 eV

V. CONCLUSIONS

The present work shows a detailed study of a- $Si₃N_{4-x}:H using first principles methods. Preparation of$ the samples proceeded via cooling from the melt using ab initio molecular dynamics. We have chosen this approach in order to avoid ambiguities between the creation of the configurations and evaluation of the electronic properties,

FIG. 14: The eigenvalues of the highest occupied and lowest unoccupied orbitals for DFT and GW_0 calculations. The latter opens a gap of 1.17 eV between lowest occupied and highest unoccupied orbital, and increases the slope.

FIG. 15: Comparison of calculated optical band gap values (see Fig. 13) with experimental values obtained by M. M. Guraya *et al..*⁶ As described in the text, the calculated values are shifted by a corresponding GW_0 correction (compare Fig.14 and Tab. V).

since we expect that the electronic properties are strongly intermingled with the structural properties, in particular at defect sites. Conventional pair or many body potentials have often difficulties to describe this relation, since the electronic properties are determined in a complicated non-trivial manner by the local environment around the defect.

As already emphasized from the outset, the present

study concentrates on the "average" structural properties, paying little attention to details about the defect concentrations and electronic defects states in and close to the gap. This is left for future studies. However, the structural models determined in this work are expected to form an excellent basis for such studies.

We have shown that the average structural properties and electronic properties are faithfully reproduced using fairly small ensembles containing only 100 atoms. Using soft potentials with a plane wave cutoff energy of 150 eV (resulting in typcially $40 - 50$ plane waves per atoms) we were able to perform calculations for up to 1 ns with reasonably modest computational resources. For each considered stoichiometry, amorphous model structures were prepared by rapidly quenching about 1000 structures from the molecular dynamics simulation into the closest local minimum. We compared these structures with larger calculations performed for systems with 200 atoms, and the results were found to be essentially identical for the small and large systems.

Analysis of the structural properties reveals that amorphous Si_3N_x is characterized by 4-fold coordinated Si atoms and 3-fold coordinated N atoms, with a very strong tendency towards hetero-coordination and formation of Si-N bonds. Si-Si and N-N bonds are only encountered, if a Si or N surplus, respectively, exists, but even then each Si and N tries to maintain its 4-fold and 3-fold coordination, respectively.

Analysis of the structure factor clearly showed the onset of density fluctuations in the N concentration, indicating N rich and N poor areas in the simulation cells. This observation in reciprocal space, was also confirmed by the analysis of the local bonding properties of Si atoms. A clear fingerprint for clustering is the number of Si atoms with 3 Si neighbors in $Si₃N_{3.5}$ and the number of Si atoms with 4 Si neighbors in $Si₃N₃$. If the formation of Si-Si bonds were entirely random, no such atoms would be expected. However, we observe a significant fraction in both cases. Although, the tendency towards clustering is not overwhelmingly strong for the preparation routes we have taken here, it is something to keep in mind for real passivation layers. To put this argument in context, one should remember that crystalline substoichiometric silicon nitrides Si_3N_{4-x} do not exist, and hence it can be only entropy that drives against phase separation in the amorphous layers, whereas energy favors phase separation into pure Si and $Si₃N₄$.

The evolution of the electronic properties of Si_3N_{4-x} is also quite remarkable. In the stoichiometric compound, the conduction band maximum is dominated by N lone pair states, whereas the valence band minimum is dominated by Si p states. However this changes drastically when decreasing the N content, causing the formation of Si-Si pairs as well as the formation of larger Si clusters (percolation, as well as clustering as described above). Within a Si pair or cluster, the bonding anti-bonding splitting is reduced compared to a Si-N bond, and thus the conduction band becomes progressively dominated by

Si bonding contributions. Likewise we expect that the valence band edges will be dominated by states originating from Si pairs or larger clusters (reduced bonding antibonding splitting). We finally note that with decreasing N content the localization of the defect states at the valence and conduction band edges decreases strongly. This is in full accordance with the picture developed above. As the Si cluster size increases, the defect states will start to spread over the Si cluster with a resultant reduced inverse participation ration. In agreement with experiment, was also find that the band gap reduces slightly from $Si₃N₄$ to $Si₃N_{3.5}$, but shows a sharp decrease for $Si₃N₃$, that we relate to the already described formation of larger Si clusters in $Si₃N₃$.

We expect that such clusters are of uttermost importance for understanding the properties of the passivation layers used in industrial solar cells. The electronic states of clusters are not well localized and extend over several Si atoms, electronically the corresponding defects states are expected to be located in the same energy range as the valence and conduction bands in crystalline Si, and hence tunneling into these states from the Si substrate is possible. We note in passing that, since such clusters are entirely missing in stoichiometric $Si₃N₄$, stoichiometric

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 $Si₃N₄$ seems to be a unsuitable model for the materials used as passivation layers in industrial solar cells.

We have also analyzed the impact of hydrogen on silicon nitrides in detail. Remarkably, it has no visible impact on the averaged properties such as the pair correlation function, the structure factor or the electronic density of states. In agreement with common chemical intuition, we have noticed, however, that hydrogen can attach to a N or Si atom, terminating a dangling bond. This is in accordance with the commonly accepted picture that it helps to reduce the number of electronic defect states in the gap, although a more careful analysis of the electronic properties of defects is required to fully resolve this issue.

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